

EZconn Overview

Innovating for a sustainable future

免責聲明

本次法說會所提供之簡報內容包括對於未來狀況之預測及評估，這些關於未來狀況之陳述乃基於公司目前可得資料所做的預測，涉及風險及不確定性，並可能發生實際結果與預期狀況有重大差異的情形，提醒各位不要過度依賴這些資訊，另除非法律要求，本公司將不負責更新或公告這些預測的結果。

公司簡介

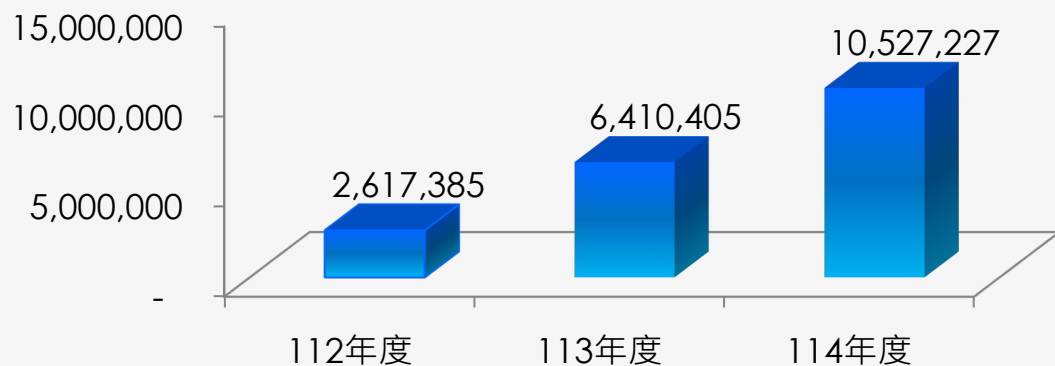
- ▶ Established in 1977
- ▶ 2025 revenue US\$ 300+ million;
2026 revenue expected to continue to grow.
- ▶ Listed on Taiwan stock market in 2015
(Stock symbol: 6442.TW)
- ▶ 1400+ employees
- ▶ Headquarters: Taiwan
- ▶ Oversea presence: USA
the Philippines,
the Czech Republic,
the People Republic of China



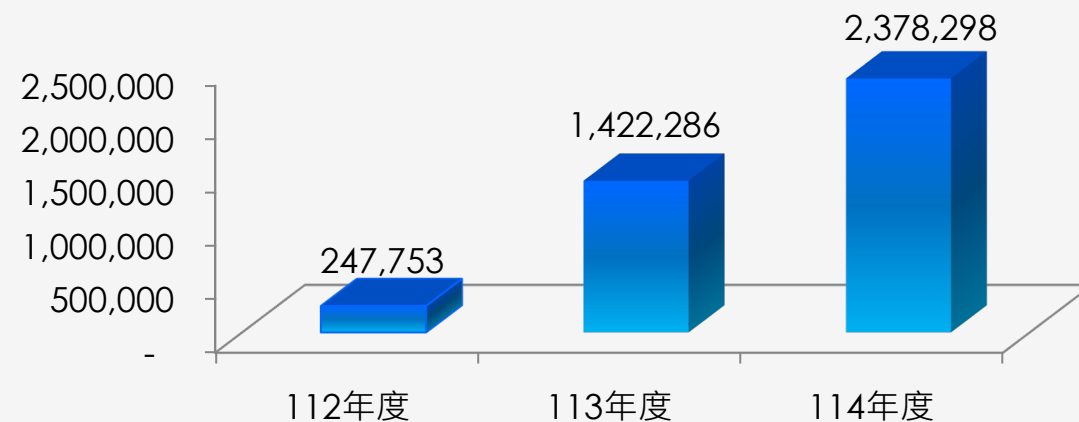
經營績效-營收與獲利

單位：新台幣仟元；%

營業收入

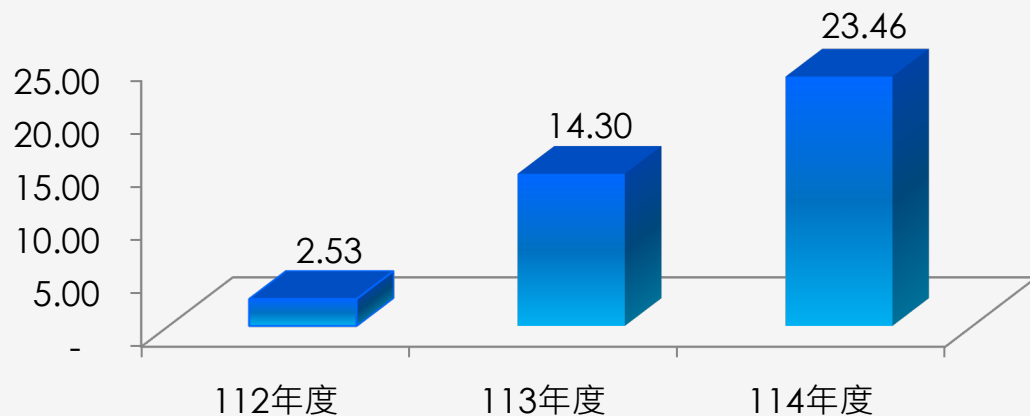


稅前利益

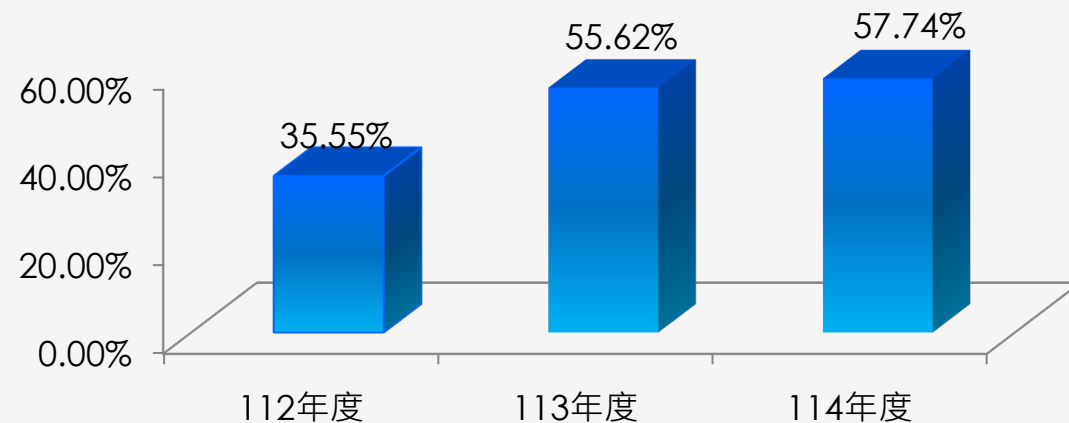


每股盈餘

新台幣元

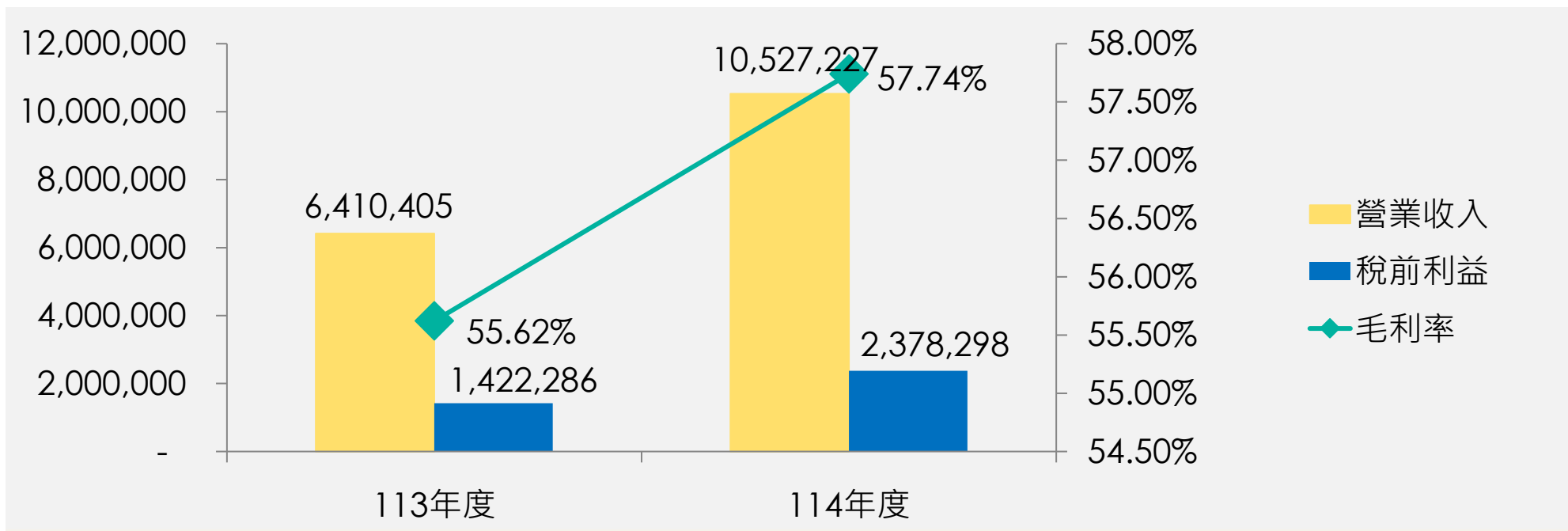


毛利率



經營績效-114年度營運狀況

單位：新台幣仟元；%



	113年度	114年度
營業收入	6,410,405	10,527,227
稅前淨利	1,422,286	2,378,298
毛利率(%)	55.62	57.74%
營業淨利	1,294,608	2,538,981
每股盈餘(元)	14.30	23.46

經營績效-財務分析

項 目		2024.12.31	2025.12.31
財務結構	負債占資產比率(%)	47.41	49.04
償債能力	流動比率(%)	231.45	268.62
獲利能力	權益報酬率(%)	36.81	33.76
	每股淨值(元)	48.63	87.90

Global Sites

Trutnov, Czech Republic



- * Research and Development
- * ISO 9001, ISO-14001
- * Wafer Level Packaging

New Taipei City, Taiwan



- * Headquarters
- * ISO-9001, ISO-14001
- * Low-volume Production



- * Research and Development
- * ISO-9001, ISO-14001
- * High-volume Production

Ningbo, China



- * Research and Development
- * ISO-9001, ISO-14001
- * High-volume Production

Lipa, Philippines



- * Research and Development
- * ISO-9001, ISO-14001
- * High-volume Production

Product Portfolio

CATV Connector /Components

F Connector
 BNC Connector
 IEC Connector
 Hardline Connector
 Filter/Attenuator
 /Isolator
 Surge Arrester
 Cable Assembly



Microwave Connector / Dipole Antenna

SMA Connector
 SMB Connector
 MCX Connector
 Dipole Antenna
 EP & Cable Assembly

Base Station Connector / Arrester

N Connector
 7/16 Connector
 Surge Arrester
 Low PIM series



Automobile Connection System

HDMI-E

 FAKRA-Connector


LAB Adaptor


50 OHM/75 OHM Adaptor


Active Components

OSA

TOSA / ROSA/ TRI-DI
 GPON / EPON BOSA
 10G /25G BOSA
 Combo ONU/OLT BOSA
 Special Application BOSA


Transceiver



Dual Mode TRX
 SFP/SFP+/XFP
 XGS PON Stick
 XGS-PON Triplexes
 XGS-PON OLT Combo /TRX


Passive Components

SC/LC/MU Series
 MPO Series
 MT-RJ Series
 FC/ST Series
 Torpedo Cable Series
 Patch Panel Series



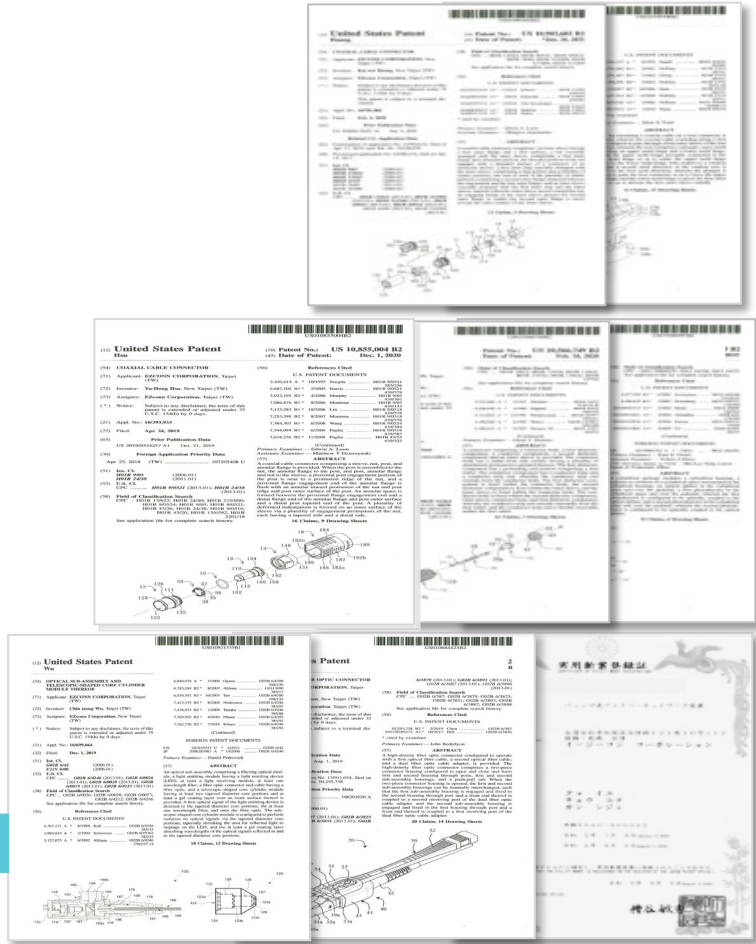
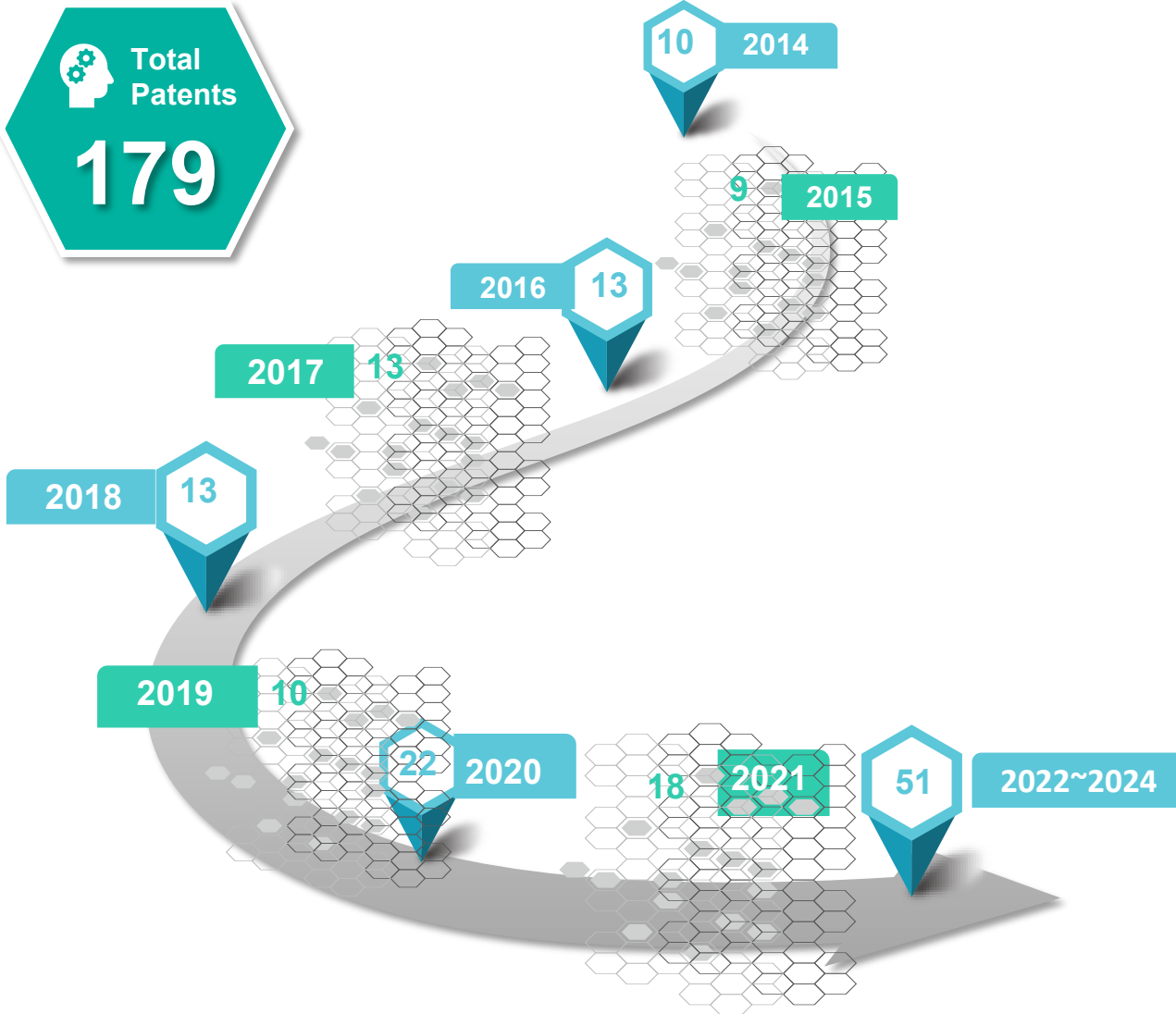

MEMS /Aerospace

MEMS Scanning Module

 AOC cable


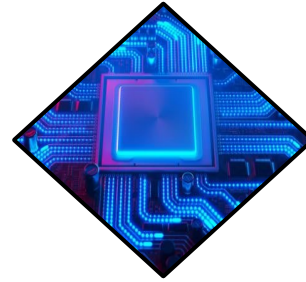
Medical

Intravenous laser module
 OCT Laser Module
 3D inspection module
 Skin-OCT


Patents overview



Core Competency



Miniaturization

Experienced in miniaturizing modules/components in various applications.



Quality Production

Attained quality recognition from 1st tier customers.



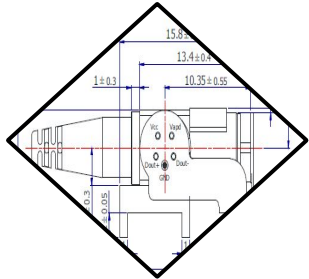
Intellectual Property

With over 180+ active issued patents and thousands of interconnect designs in its library.



Precision Machinery

Maintaining micro level precision machining capabilities in mass production.



Customized Design

Customized designs of optical, mechanical, and electronic packaging.

Market Sectors

▶ **Broadband Networks – Access (Last-Mile)**

- Optical engines for “Fiber to the Home” (FTTH) for Telcos
- RF interconnects for cable service providers

▶ **AI infrastructure – Hyperscalers (large-scale data centers)**

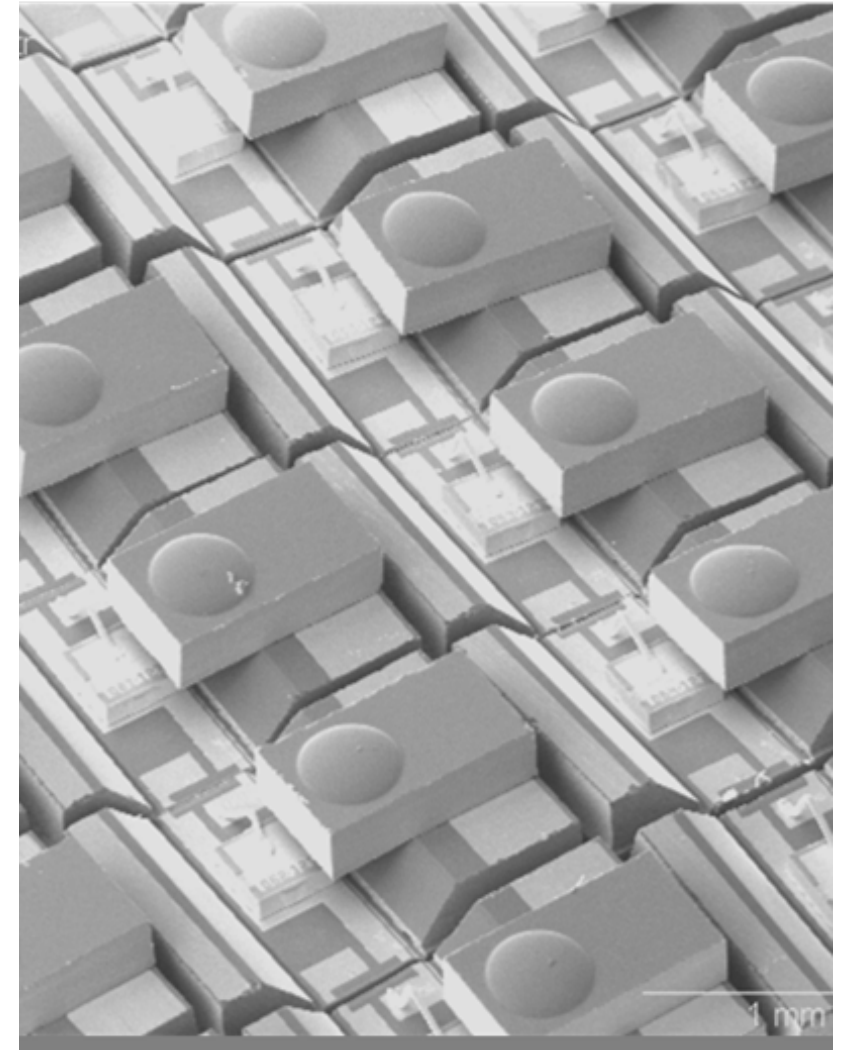
- **Scale-out:** high-density fiber deployment connecting data centers' physical structures
- **Scale-up:** active silicon photonic CPO-ELS* modules to increase speed and reduce power consumption for GPU's (expected 2026)

▶ **Biomedical & Scientific**

- Miniaturized optical units for testing and probing instruments using OCT, PCR, Raman technologies, and for quantum-computing testing

▶ **Aerospace & Defense**

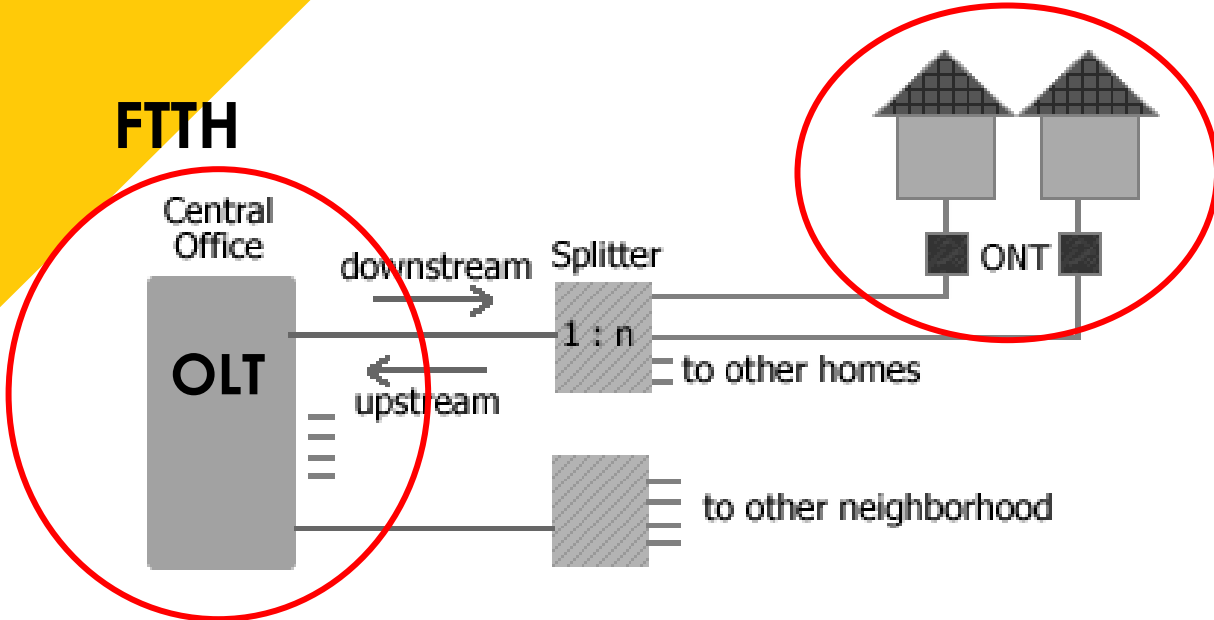
- Replacement components for fighter jets
- High-frequency RF interconnects



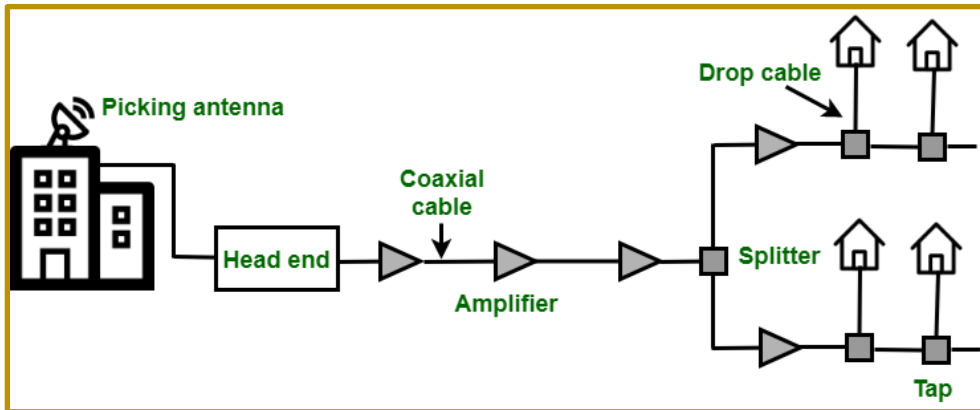
* CPO-ELS stands for “co-packaging optics with external laser source” - essential chip packaging for AI processing at server level in data centers.

Broadband Networks – Access (Last-Mile)

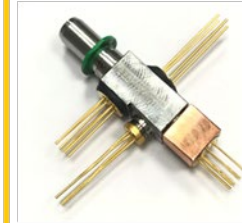
FTTH



Cable Network



10G BOSA
(Bi-directional
optical sub-
assemblies),
BOSA Combo
(1G,10G, 25G)







Optical
Transceivers

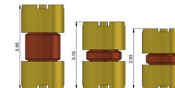
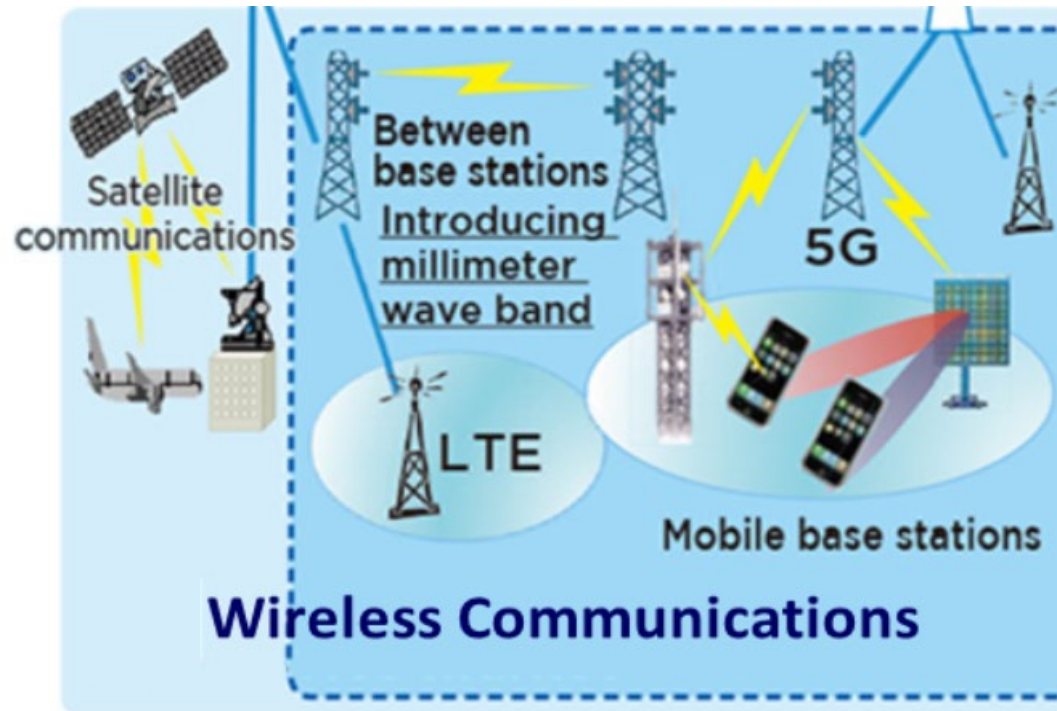
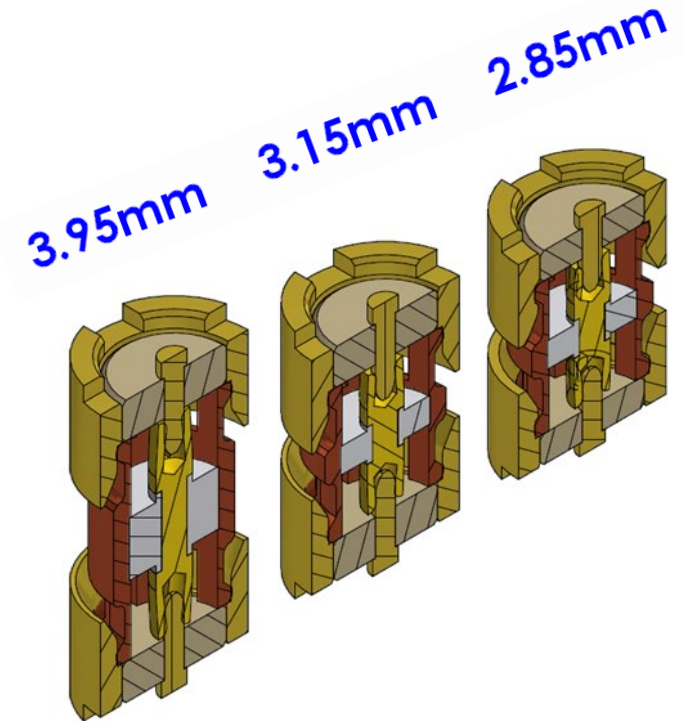


RF connectors,
amplifiers, filters,
cables, etc.



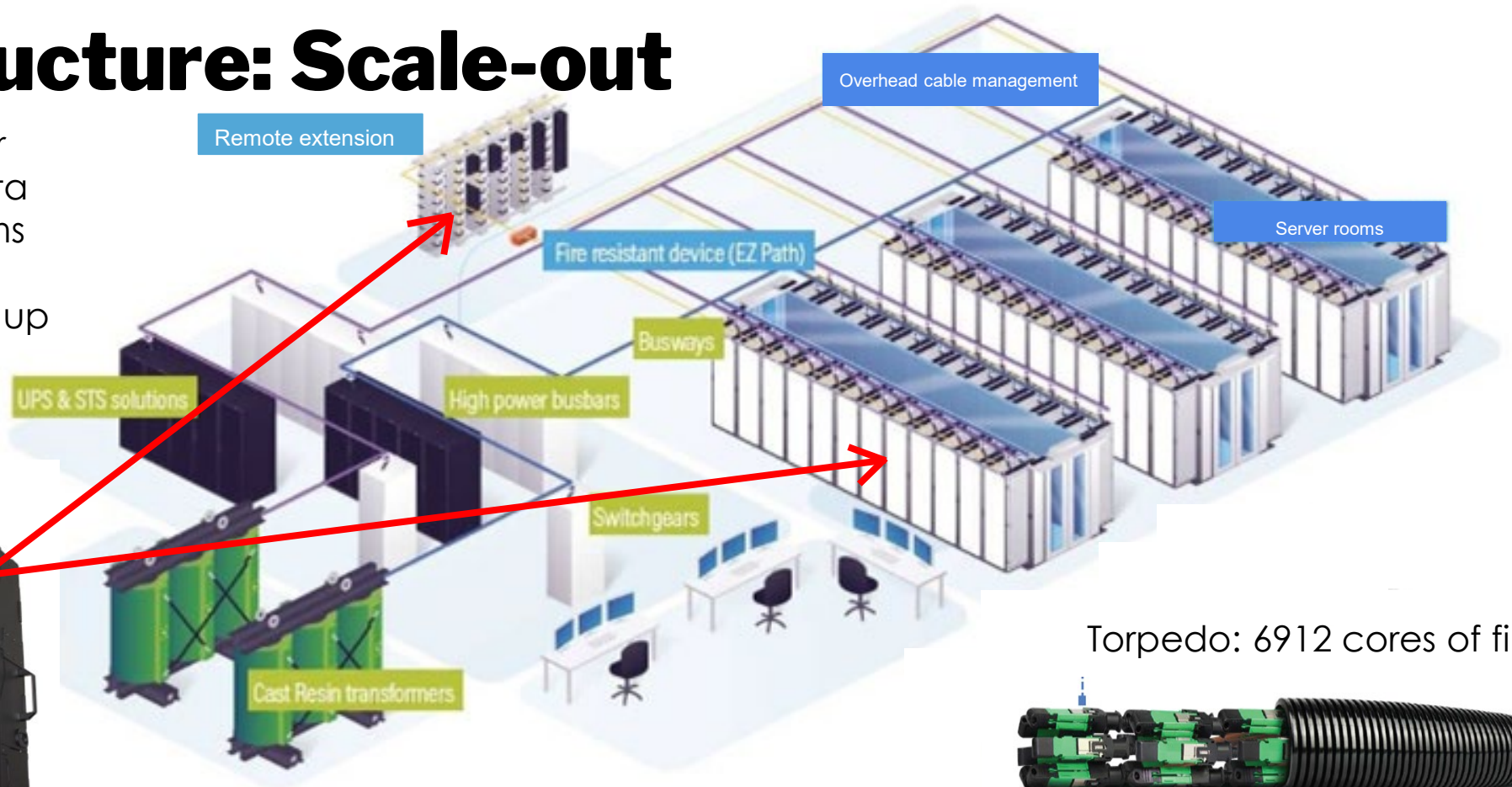
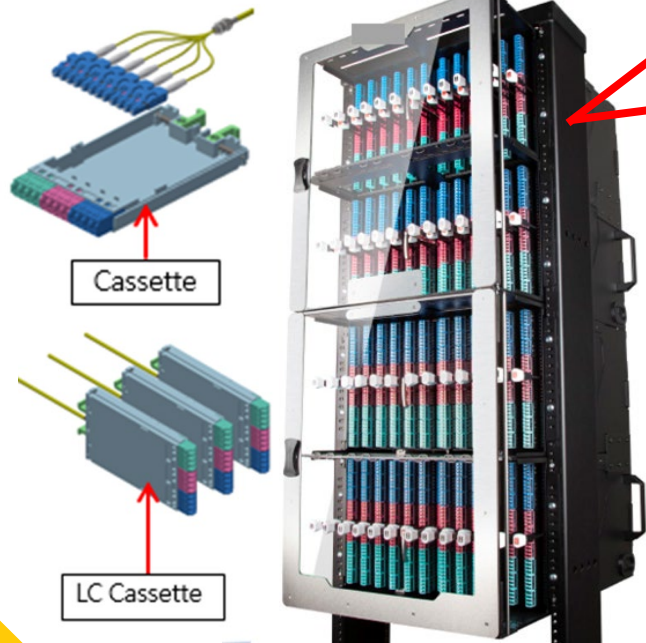
Broadband Networks – Access (Last-Mile)

	SMP	SMPM	1.85mm	2.4mm	2.4mm
5G mmWave 40 GHz~ 65 GHz					

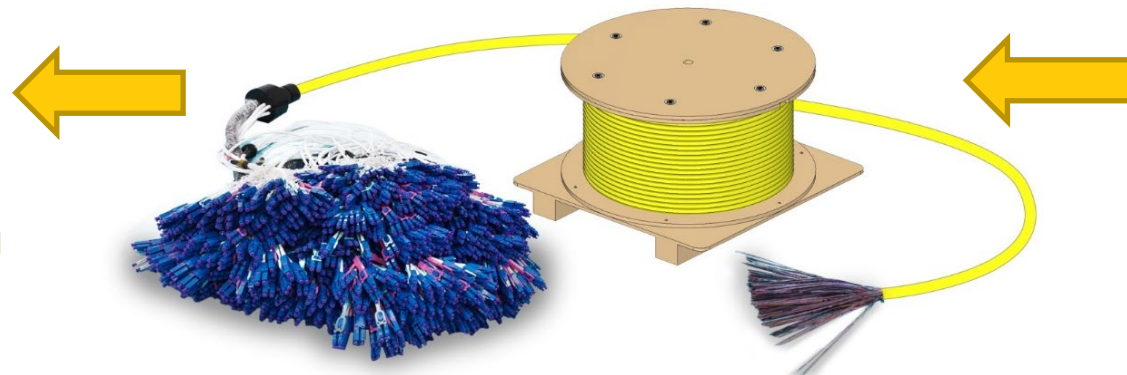


AI infrastructure: Scale-out

High density optical fiber interconnects linking data center structures or rooms for AI infrastructure .
Torpedo cable contains up to 6912 fiber cores.

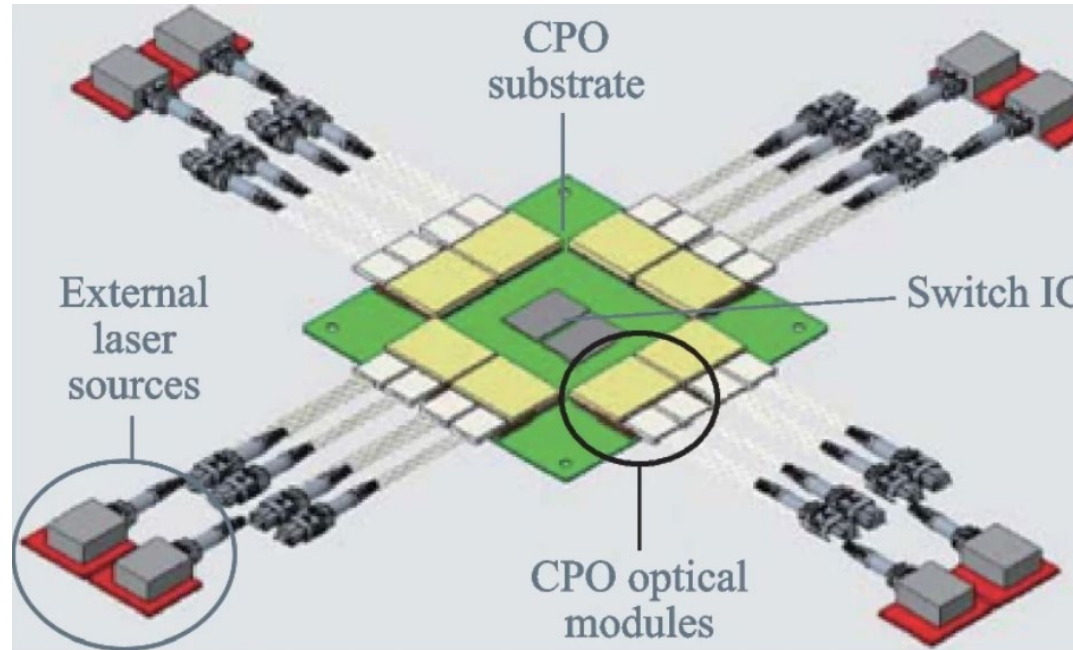


Torpedo: 6912 cores of fiber

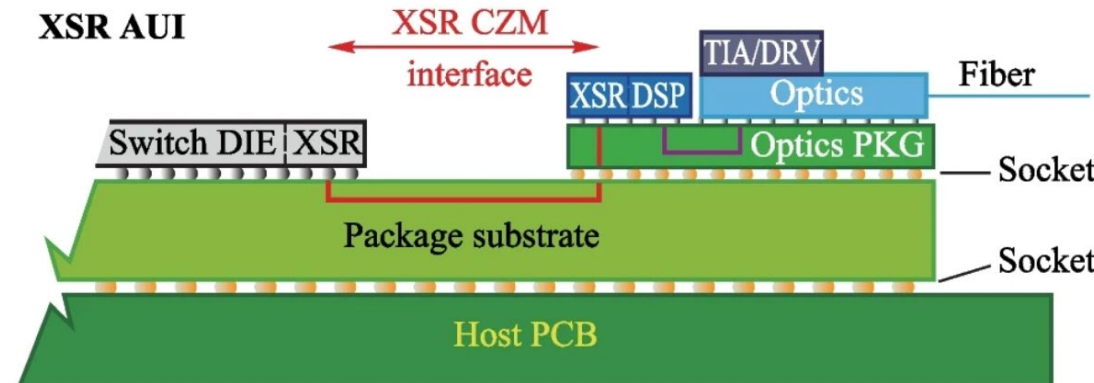


AI infrastructure: Scale-up

**CPO ELS modules
expected 2026**



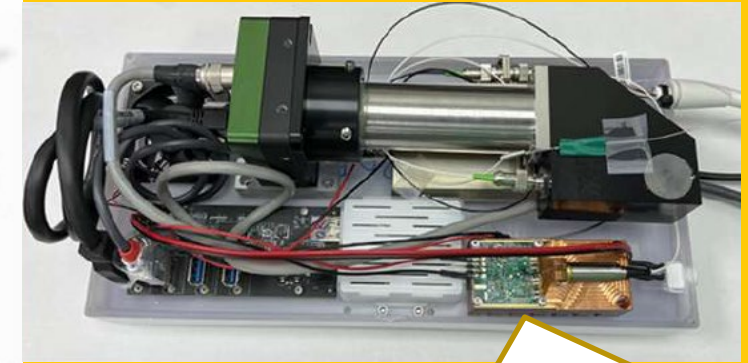
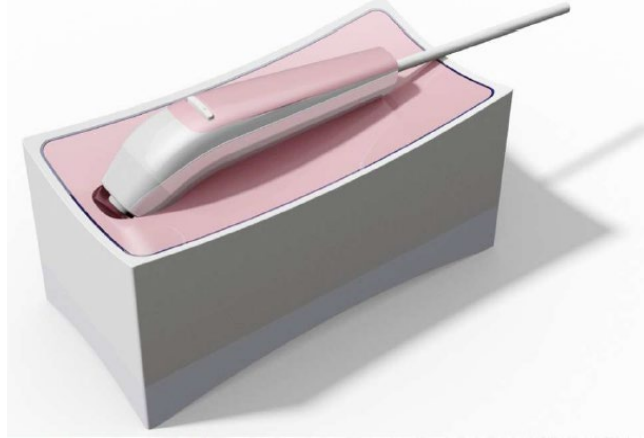
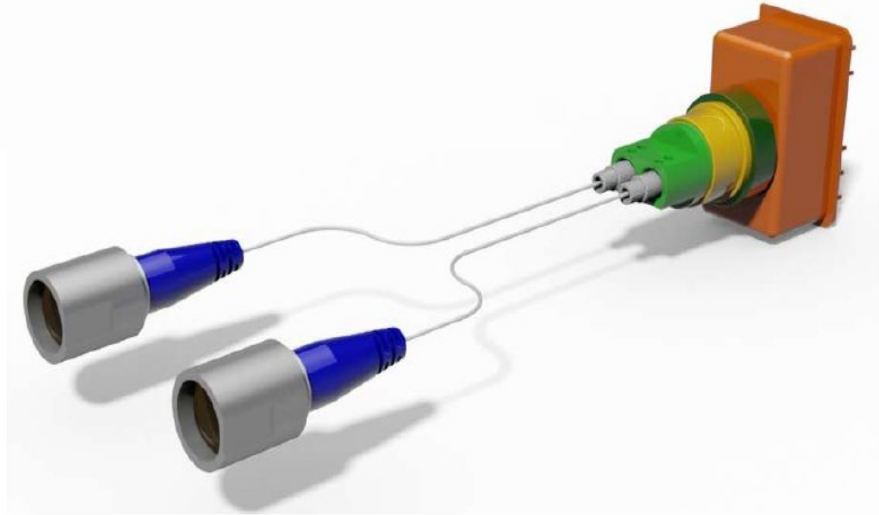
Top view



Side view

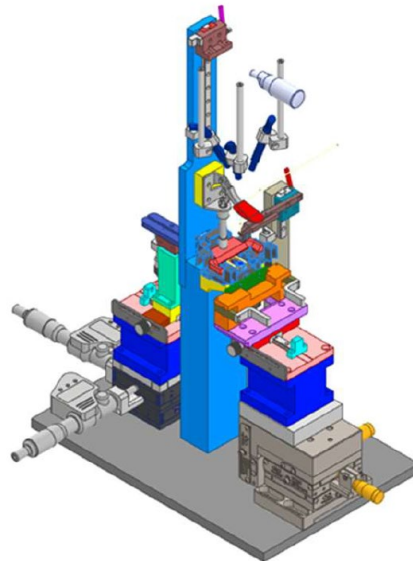
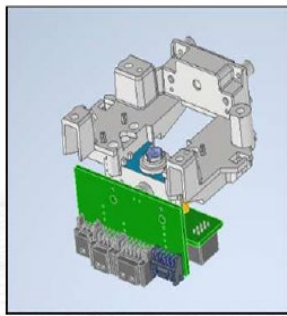
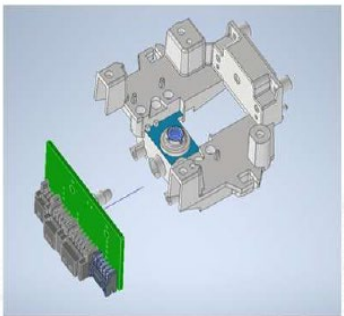
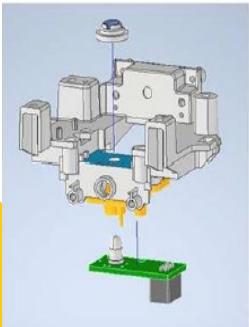
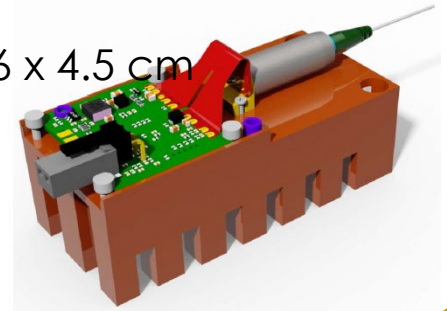
Bio Medical & Scientific: OCT and PCR

EZconn also provides optical components for PCR (Polymerase chain reaction) machines.

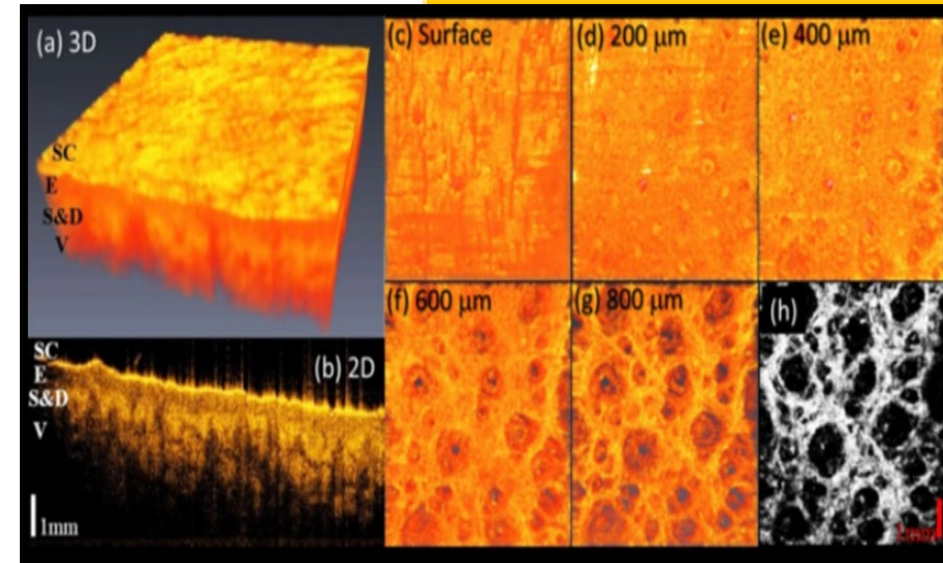


Used as light source module in OCT (Optical Coherence Tomography) products examining under-skin, eyes, teeth, etc.

Size: 11x 6 x 4.5 cm

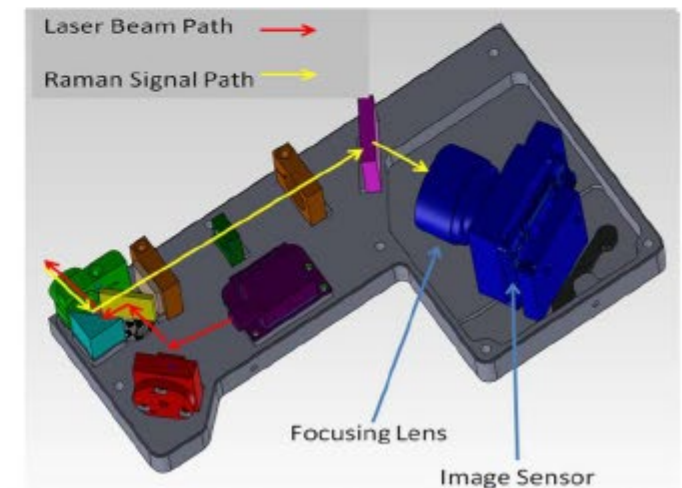
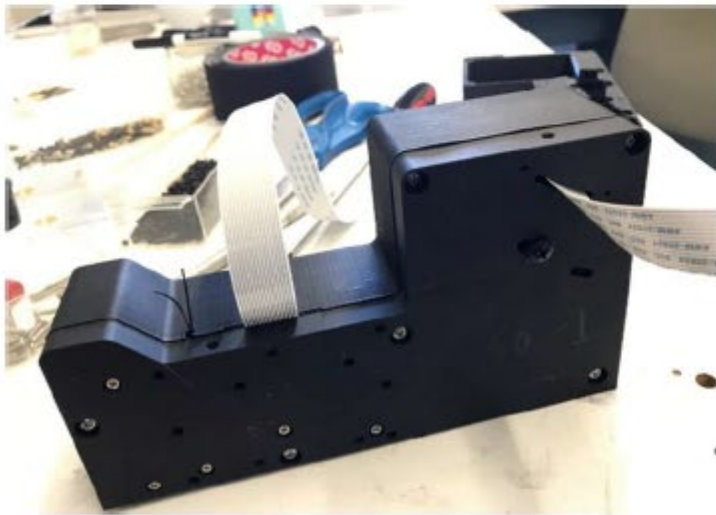
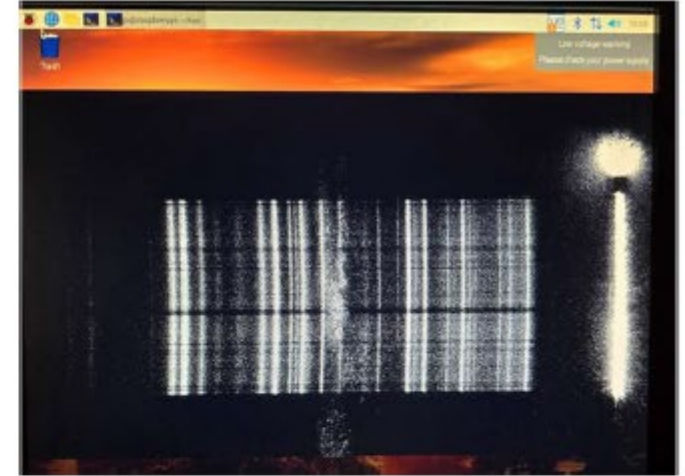


EZconn Confidential



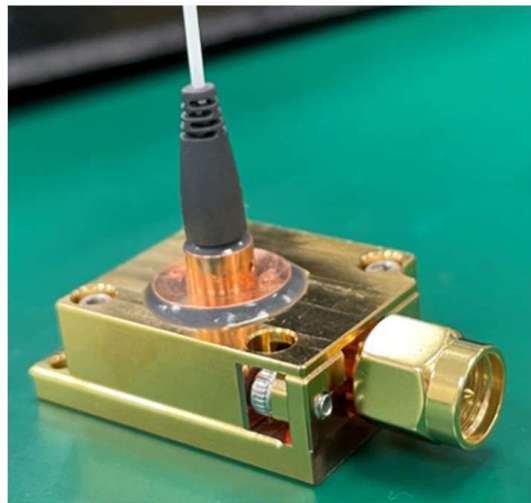
Bio Medical: Miniaturized Raman Spectrometers

Application: Currently mainly used by the law enforcement to detect drugs and medicines

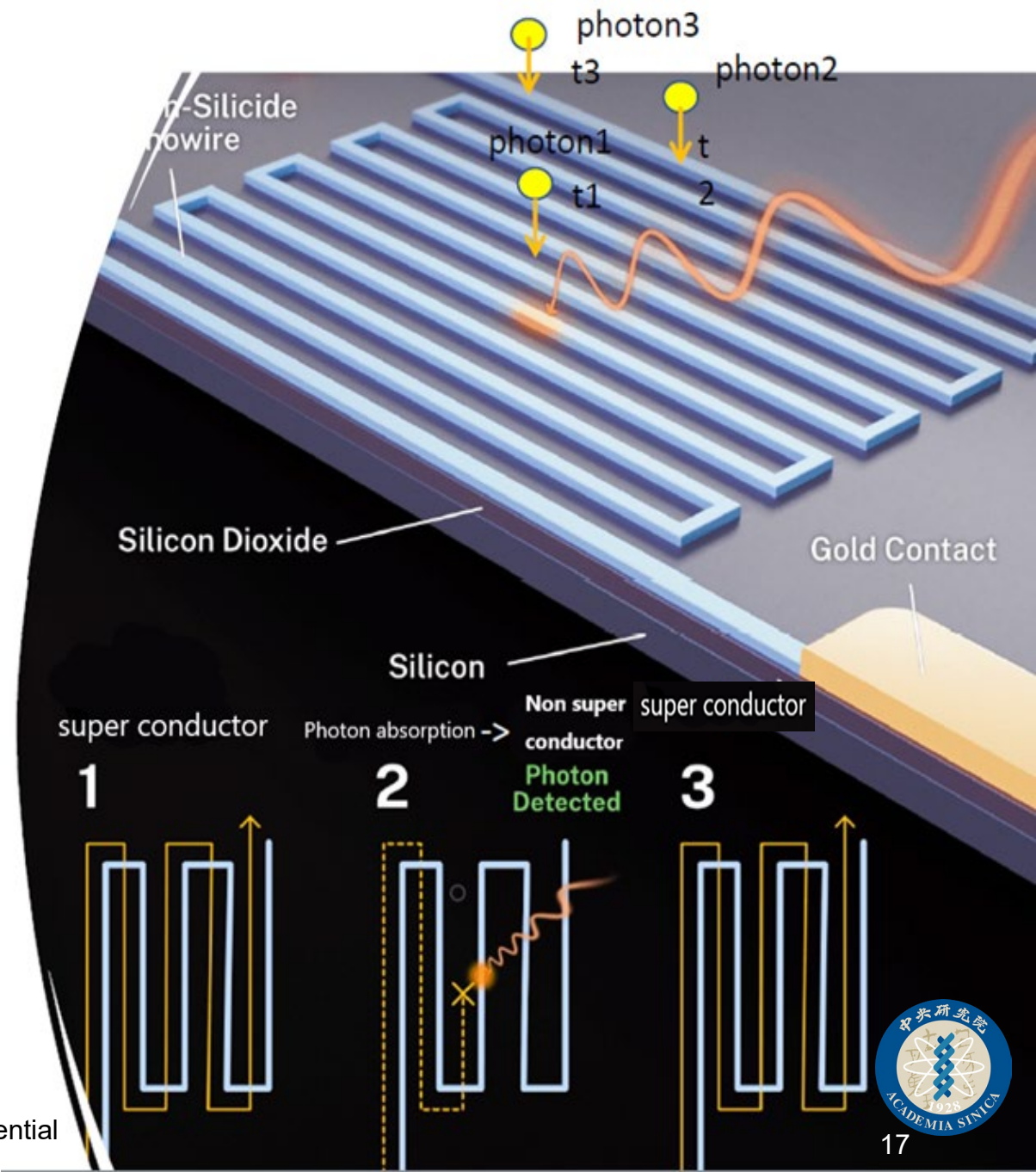
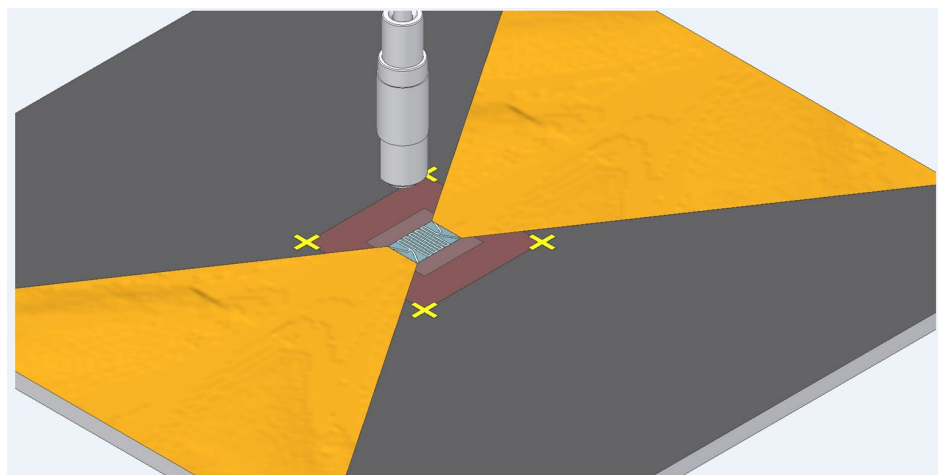
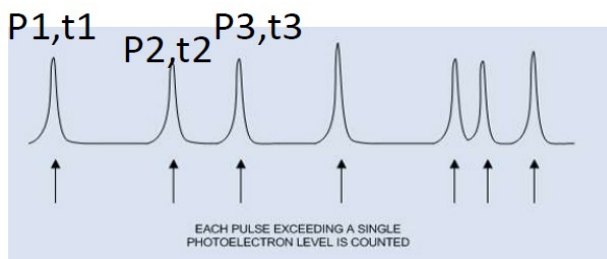


Biomedical & Scientific: Quantum-computing testing

Superconducting Nanowire Single-Photon Detector

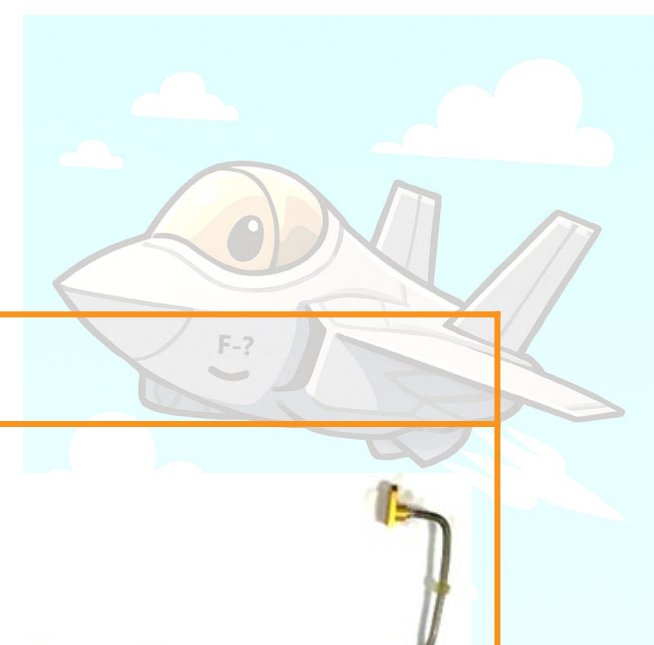


Photon counting
in detective mode with very
low dark count
Working Temp: 4°K(-269°C)




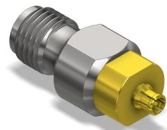

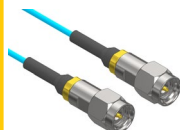

Aerospace & Defense:

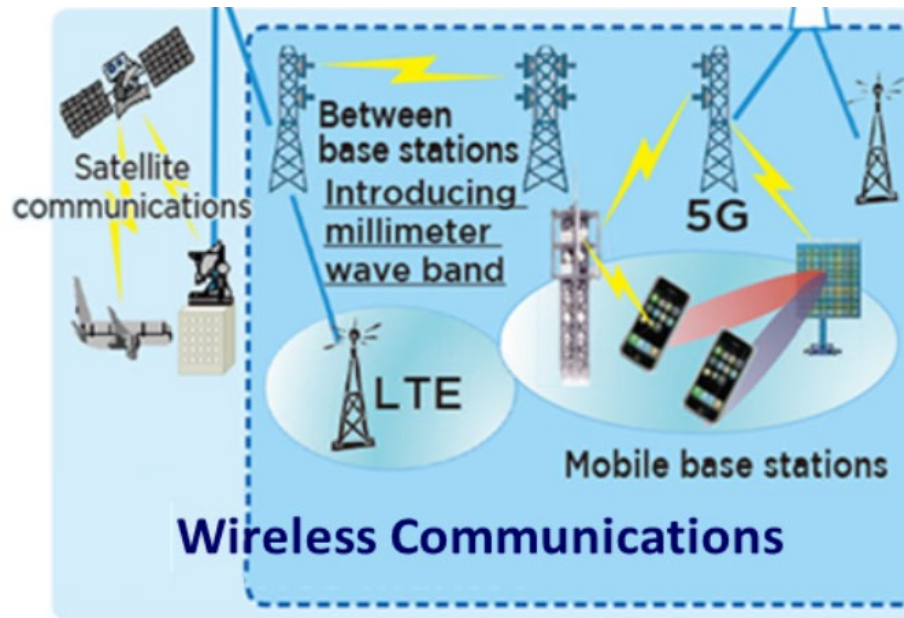
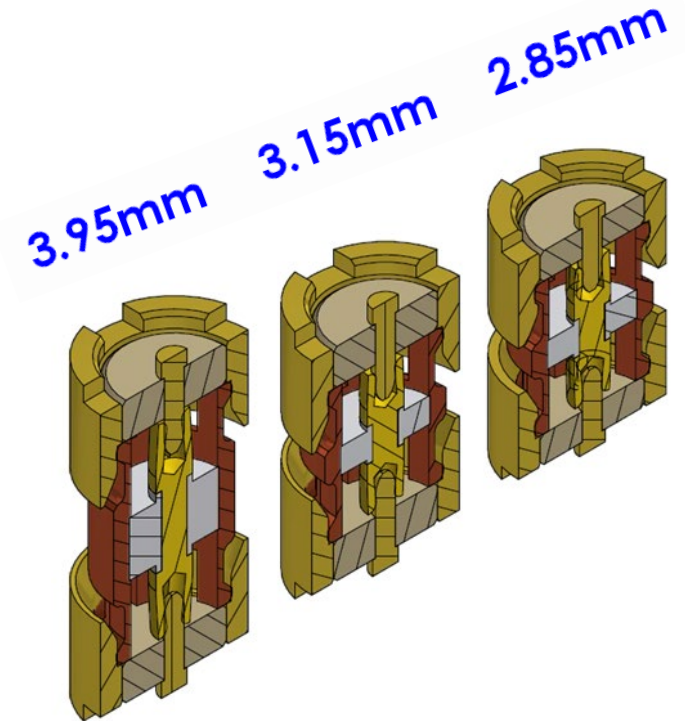
Replacement components for fighter jets



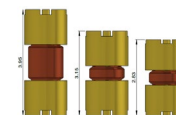
Item	Photo
<p>High frequency jumper for aerospace (BMA SEMI-RIGID)</p>	Three high frequency jumpers made of semi-rigid coaxial cable. They have different lengths and configurations of connectors at both ends, including SMA and N-type connectors.
<p>RF relays for aerospace</p>	Technical drawings of RF relays. On the left, three cylindrical relays are shown with a vertical dimension line indicating a height of 23. On the right, a larger rectangular relay is shown with a horizontal dimension line indicating a width of 170 and a vertical dimension line indicating a height of 33.2. The drawings show various ports and connectors on the relays.
<p>Micro-D to HDMI for aerospace</p>	A photograph of a black cable with a Micro-D connector on one end and an HDMI connector on the other. To the right, there are two 3D CAD models of the connectors: one showing the Micro-D connector and the other showing the HDMI connector.

Aerospace & Defense: High-frequency RF interconnects

5G mmWave 40 GHz~ 65 GHz	SMP	SMPM	1.85mm	2.4mm	2.4mm
					



16.25mm





Thank you